







maxim integrated_™

ΠΠΕ: PACKAGE DUTLINE, SDT 6L BDDY

APPROVAL

DOCUMENT CONTROL NO. 21-0058

REV.

-DRAWING NOT TO SCALE-

NOTES:

1. ALL DIMENSIONS ARE IN MILLIMETERS UNLESS OTHER SPECIFIED.

FOOT LENGTH MEASURED AT INTERCEPT POINT BETWEEN DATUM A & LEAD SURFACE.

- 3. PACKAGE DUTLINE EXCLUSIVE DF MOLD FLASH & METAL BURR, MOLD FLASH, PROTRUSION OR METAL BURR SHOULD NOT EXCEED 0.25mm.
- 4. PACKAGE DUTLINE INCLUSIVE OF SOLDER PLATING.
- PIN 1 IS LOWER LEFT PIN WHEN READING TOP MARK FROM LEFT TO RIGHT.
- ⚠ PIN 1 I.D. DOT IS Ø0.3mm MIN. LOCATED ABOVE PIN 1.
- 7. MEETS JEDEC MO178, VARIATION AB.
- 8. SOLDER THICKNESS MEASURED AT FLAT SECTION OF LEAD BETWEEN 0.08mm AND 0.15mm FROM LEADTIP.
- 9. LEAD TO BE COPLANAR WITHIN 0.1mm.
- 10. NUMBER OF LEADS SHOWN ARE FOR REFERENCE ONLY.
- 1 MARKING IS FOR PACKAGE ORIENTATION REFERENCE ONLY.
- 12. MATERIAL MUST BE COMPLIANT WITH MAXIM SPECIFICATION 10-0131 FOR SUBSTANCE CONTENT, MUST BE EU ROHS COMPLIANT WITHOUT EXEMPTION AND PB-FREE.
- 13. ALL DIMENSIONS APPLY TO BOTH LEADED (-) AND POFREE (+) PKG. CODES.

SYMBOL	MIN	NDMINAL	MAX
Α	0.90	1.25	1,45
A1	0.00	0.05	0.15
A2	0.90	1.10	1,30
b	0.35	0.40	0.50
С	0.08	0.15	0.20
D	2.80	2.90	3.00
Е	2.60	2.80	3.00
E1	1.50	1.625	1.75
L	0.35	0.45	0.60
L1	0.60 REF.		
e1	1.90 BSC.		
е	0.95 BSC.		
a	0°	2,5°	10°

PKG CDDES: U6-1, U6-1A, U6-2, U6-4, U6-4A, U6-5, U6-5A, U6CN-2, U6F-6, U6SN-1, U6-8, U6-9, U6-1C

*** U6-9 TO BE USED FOR RF50 PARTS ONLY WHICH USES A SI SPACER
*** U6-5 USES LOW STRESS MOLD COMPOUND



TITLE:

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APPROVAL DOCUMENT CONTROL NO. REV. 2